## **Declaration for U.S. Patent Application**

As a below named	inventor, I hereby declar	that:			
My residence, post	office address and citize	nship are as sta	ited belov	w next to my name.	
names are listed bel (Insert Title) N	low) of the subject matte	r which is clain IAVING SPIN	ned and f	or which a patent is soug UN-OUT DIAGNOSING	ginal, first and joint inventor (if plural ht on the invention entitled G FUNCTION
the specification of	which is attached hereto	uniess the fon-	owing is	CHECKEU	
		as United as amended on			T International Application Number ble).
	have reviewed and undenendment referred to abo		ents of th	ne above-identified specif	ication, including the claim(s), as
§ 1.56.	•				n Title 37, Code of Federal Regulations, any foreign application(s) for patent or
filing date before th	e listed below and have a nat of the application for				patent or inventor's certificate having a
(List prior	2000-169960	Japan	0	7/06/2000	Priority Claimed  XX Yes No
foreign applications.	(Number)	(Country)		y/Month/Year Filed)	Yes No
See note A on back of this	(Number)	(Country)	(Day/Month/Year Filed)		YesNo
page)	(Number)	(Country)		y/Month/Year Filed)	Yes No
	(Number)	(Country)	(Day	y/Month/Year Filed)	
(See note B on back	k of this page)	_ See attache	ed list for	additional prior foreign	applications
subject matter of ea the first paragraph o as defined in Title 3	nch of the claims of this a of Title 35, United States (	pplication is no Code, § 112, I ad lations, § 1.56	ot disclos cknowled which be	ed in the prior United Sta Ige the duty to disclose inf	lication(s) listed below and, insofar as the sapplication in the manner provided be formation which is material to patentabilith the filing date of the prior application and
(List Prior U.S.					
Applications)	(Appln. Serial No.	(Filing I	Date)	(Status: Patented, Pend	ling, Abandoned)
	(Appln. Serial No.	(Filing I	Date)	(Status: Patented, Pend	ling, Abandoned)
	(Appln. Serial No.)	(Filing I	Date)	(Status: Patented, Pend	ling, Abandoned)



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Please direct all communications to the following address:



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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C	Full name of sole or first inventor (given name, family name) _	Yoshiaki AKAMATSU					
abo <u>v</u> e)	Inventor's signature Joshiaki Akamatsu	- 1. / \ . /					
ior iO	Inventor's signature 1091, aki 17 kana 13 k	Date					
ij Li	Residence Yamatokoriyama-shi, Nara, Japan	Citizenship Japan					
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<b>:</b>							
[]							
	inventor (given name, family name) Makoto FUJISHIMA						
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Full name of third inventor (given name, family name)							
Inventor's signature _	Da	te					
Residence		Citizenship					
Post Office Address							

## **NOTES**

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- .C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.